

TT-P073

Effect of Non-lattice Oxygen Concentration and Micro-structure on Resistance Switching Characteristics in Nb-doped HfO₂ by DC Magnetron Co-Sputtering

이규민, 김종기, 김영재, 김종일, 손현철

연세대학교 신소재공학과

In this study, we investigated that the resistance switching characteristics of Nb-doped HfO₂ films with increasing Nb doping concentration. The Nb-doped HfO₂ based ReRAM devices with a TiN/Nb-doped HfO₂/Pt/Ti/SiO₂ were fabricated on Si substrates. The Nb-doped HfO₂ films were deposited by reactive dc magnetron co-sputtering at 300°C and oxygen partial ratio of 60% (Ar: 16sccm, O₂: 24sccm). Micro-structure of Nb-doped HfO₂ films and atomic concentration were investigated by XRD, TEM, and XPS, respectively. The Nb-doped HfO₂ films showed set/reset resistance switching behavior at various Nb doping concentrations. The process voltage of forming/set is decreased and whereas the initial current level is increased in doped HfO₂ films. However, the switching properties of Nb-doped HfO₂ were changed above the specific doping concentration of Nb. The change of resistance switching behavior depending on doping concentration was discussed in terms of concentration of non-lattice oxygen and micro-structure of Nb-doped HfO₂.

Keywords: resistance switching, Nb doping concentration, non-lattice oxygen, micro-structure

TT-P074

Optical Characteristics of Ge_{0.99}Sn_{0.01}/Si and Ge/Si Using Photoreflectance Spectroscopy

Hyun-Jun Jo¹, So Mo Geun¹, Jong Su Kim^{1*}, Mee-Yi Ryu², Yung Kee Yeo³, J. Kouvetakis⁴

¹Department of Physics, Yeungnam University, Gyeongsan 712-749, ²Department of Physics, Kangwon National University, Kangwon-do 200-701, Korea, ³Department of Engineering Physics, Air Force Institute of Technology, Ohio 45433, ⁴Department of Chemistry and Biochemistry, Arizona State University, Arizona 85287, USA

We have investigated optical characteristics of p-Ge_{0.99}Sn_{0.01} and Ge films grown on Si substrates using photoreflectance (PR) spectroscopy. The Ge_{0.99}Sn_{0.01} and Ge films were grown by using an ultra-high vacuum chemical vapor deposition and molecular beam epitaxy methods, respectively. PR spectra were measured at 25 K and an extended InGaAs detector was used. By comparing Ge_{0.99}Sn_{0.01}/Si and Ge/Si spectra, we observed the signals related to direct transition and split-off band of Ge_{0.99}Sn_{0.01}. The transition energies of Ge_{0.99}Sn_{0.01} and Ge films were approximately 0.74 and 0.84 eV, respectively. Considering the shift of split-off band transition of Ge_{0.99}Sn_{0.01}, we suppose that the transition at 0.74 eV is attributed to direct transition between Γ band and valence band. The temperature- and excitation power-dependent PR spectra were also measured.

Keywords: Ge, GeSn, PR